

L Number	Hits	Search Text	DB	Time stamp
1	261	magnetic adj shunt and (stage substrate wafer)	USPAT; EPO; JPO; DERWENT	2004/02/09 09:56
3	30	((magnetic adj shunt and (stage substrate wafer)) and mov\$5) and optic\$5	USPAT; EPO; JPO; DERWENT	2004/02/09 09:57
2	178	(magnetic adj shunt and (stage substrate wafer)) and mov\$5	USPAT; EPO; JPO; DERWENT	2004/02/09 10:17
-	1647	magnetic adj shunt	USPAT; EPO; JPO; DERWENT	2004/02/09 09:56
-	19	(magnetic adj shunt) and 250/\$.ccls.	USPAT; EPO; JPO; DERWENT	2003/02/26 13:01
-	92	(magnetic adj shunt) and optic\$5	USPAT; EPO; JPO; DERWENT	2003/10/28 14:34
-	902	shunt and 250/\$.ccls.	USPAT; EPO; JPO; DERWENT	2003/02/26 13:02
-	224	(shunt and 250/\$.ccls.) and magnetic	USPAT; EPO; JPO; DERWENT	2003/02/26 13:02
-	113	((shunt and 250/\$.ccls.) and magnetic) and (stage wafer)	USPAT; EPO; JPO; DERWENT	2003/02/26 13:09
-	208	magnetic adj shunt same (stage hold\$4 wafer substrate base)	USPAT; EPO; JPO; DERWENT	2003/02/26 14:43
-	14	(magnetic adj shunt same (stage hold\$4 wafer substrate base) same (mov\$4 translat\$4 position\$4)) and optic\$4	USPAT; EPO; JPO; DERWENT	2003/02/26 14:45
-	106	magnetic adj shunt same (stage hold\$4 wafer substrate base) same (mov\$4 translat\$4 position\$4)	USPAT; EPO; JPO; DERWENT	2003/02/26 15:29
-	66272	magnetic same (stage hold\$4 wafer substrate base) same (mov\$4 translat\$4 position\$4)	USPAT; EPO; JPO; DERWENT	2003/02/26 15:31
-	43181	magnetic same (mov\$4 translat\$4 position\$4) with (stage hold\$4 wafer substrate base)	USPAT; EPO; JPO; DERWENT	2003/02/26 15:41
-	1216	(magnetic same (mov\$4 translat\$4 position\$4) with (stage hold\$4 wafer substrate base)) and permeable	USPAT; EPO; JPO; DERWENT	2003/02/26 15:42
-	337	((magnetic same (mov\$4 translat\$4 position\$4) with (stage hold\$4 wafer substrate base)) and permeable) and (optic\$ illuminat\$5)	USPAT; EPO; JPO; DERWENT	2003/02/26 15:47
-	43	((((magnetic same (mov\$4 translat\$4 position\$4) with (stage hold\$4 wafer substrate base)) and permeable) and (optic\$ illuminat\$5)) and 250/\$.ccls.	USPAT; EPO; JPO; DERWENT	2003/02/26 16:17
-	18	((("4310764") or ("4465934") or ("4607167") or ("4628466") or ("4866280") or ("4985634") or ("5446722") or ("6285097")).PN.	USPAT; EPO; JPO; DERWENT	2003/02/26 16:18
-	8	((("4310764") or ("4465934") or ("4607167") or ("4628466") or ("4866280") or ("4985634") or ("5446722") or ("6285097")).PN.	USPAT	2003/02/26 16:18
-	8	((("4310764") or ("4465934") or ("4607167") or ("4628466") or ("4866280") or ("4985634") or ("5446722") or ("6285097")).PN.) and magnet\$4	USPAT; EPO; JPO; DERWENT	2003/02/27 08:06
-	3	((("4444643") or ("4714536") or ("5320728")).PN.	USPAT	2003/02/27 08:08
-	310	magnetic adj shunt.clm.	USPAT; EPO; JPO; DERWENT	2003/02/27 08:09

-	3148085	(magnetic adj shunt.clm.) and stage wafer base	USPAT; EPO; JPO; DERWENT	2003/02/27 08:09
-	141	(magnetic adj shunt.clm.) and (stage wafer base)	USPAT; EPO; JPO; DERWENT	2003/02/27 08:09
-	2	("5415754").PN.	USPAT; EPO; JPO; DERWENT	2003/02/28 09:49
-	745	(magnetic adj shunt) and mov\$5	USPAT; EPO; JPO; DERWENT	2003/10/28 14:35
-	65	((magnetic adj shunt) and mov\$5) and optic\$7	USPAT; EPO; JPO; DERWENT	2003/10/28 14:36